

FGZ50N65WE

Discrete IGBT (High-Speed W series) 650V / 50A

Features

- Low power loss
- Low switching surge and noise
- High reliability, high ruggedness (RBSOA, SCSOA etc.)

Applications

- Uninterruptible power supply
- PV Power conditioner
- Inverter welding machine

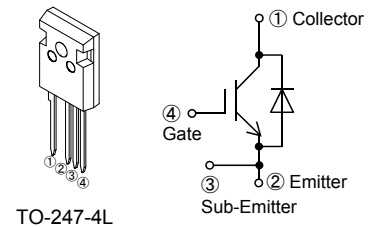


Maximum Ratings and Characteristics

Absolute Maximum Ratings at $T_{vj}=25^{\circ}\text{C}$ (unless otherwise specified)

Items	Symbol	Characteristics	Unit	Remarks
Collector-Emitter Voltage	V_{CES}	650	V	
Gate-Emitter Voltage	V_{GES}	± 20	V	
Transient Gate-Emitter Voltage		± 30	V	$T_r < 1\mu\text{s}$
DC Collector Current	$I_{C@25}$	70	A	$T_c = 25^{\circ}\text{C}$
	$I_{C@100}$	50	A	$T_c = 100^{\circ}\text{C}$
Pulsed Collector Current	I_{CP}	200	A	Note *1
Turn-Off Safe Operating Area	-	200	A	$V_{CE} \leq 650\text{V}, T_{vj} \leq 175^{\circ}\text{C}$
Diode Forward Current	$I_{F@25}$	73	A	
	$I_{F@100}$	50	A	
Diode Pulsed Current	I_{FP}	200	A	Note *1
IGBT Max. Power Dissipation	P_{D_IGBT}	330	W	$T_c = 25^{\circ}\text{C}$
FWD Max. Power Dissipation	P_{D_FWD}	170	W	$T_c = 25^{\circ}\text{C}$
Operating Junction Temperature	T_{vj}	-40 ~ +175	$^{\circ}\text{C}$	
Storage Temperature	T_{stg}	-55 ~ +175	$^{\circ}\text{C}$	

Equivalent circuit



Note *1 : Pulse width limited by T_{vjmax} .

Electrical characteristics at $T_{vj} = 25^{\circ}\text{C}$ (unless otherwise specified) Static Characteristics

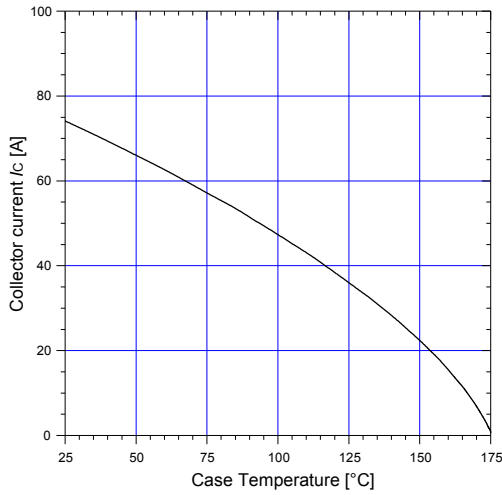
Description	Symbol	Conditions	min.	typ.	max.	Unit	
Zero Gate Voltage Collector Current	I_{CES}	$V_{CE} = 650\text{V}, V_{GE} = 0\text{V}$	$T_{vj} = 25^{\circ}\text{C}$	-	-	250	μA
			$T_{vj} = 175^{\circ}\text{C}$	-	-	2	mA
Gate-Emitter Leakage Current	I_{GES}	$V_{CE} = 0\text{V}, V_{GE} = \pm 20\text{V}$	-	-	200	nA	
Gate-Emitter Threshold Voltage	$V_{GE(th)}$	$V_{CE} = 20\text{V}, I_C = 50\text{mA}$	3.0	4.0	5.0	V	
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	$V_{GE} = 15\text{V}, I_C = 50\text{A}$	$T_{vj} = 25^{\circ}\text{C}$	-	1.80	2.20	V
			$T_{vj} = 125^{\circ}\text{C}$	-	2.05	-	
			$T_{vj} = 175^{\circ}\text{C}$	-	2.10	-	
Input Capacitance	C_{ies}	$V_{CE} = 25\text{V}$	-	3650	-	pF	
Output Capacitance	C_{oes}	$V_{GE} = 0\text{V}$	-	105	-		
Reverse Transfer Capacitance	C_{res}	$f = 1\text{MHz}$	-	80	-		
Gate Charge	Q_G	$V_{CC} = 520\text{V}$ $I_C = 50\text{A}$ $V_{GE} = 15\text{V}$	-	215	-	nC	
Turn-On Delay Time	$t_{d(on)}$	$T_{vj} = 25^{\circ}\text{C}, V_{CC} = 400\text{V}$ $I_C = 25\text{A}, V_{GE} = 15\text{V}$ $R_{G(on)} = 10\Omega, R_{G(off)} = 20\Omega$ Energy loss include "tail" and FWD reverse recovery.	-	26	-	ns	
Rise Time	t_r		-	12	-		
Turn-Off Delay Time	$t_{d(off)}$		-	350	-		
Fall Time	t_f		-	23	-		
Turn-On Energy	E_{on}		-	0.12	-		mJ
Turn-Off Energy	E_{off}	-	0.40	-			
Turn-On Delay Time	$t_{d(on)}$	$T_{vj} = 150^{\circ}\text{C}, V_{CC} = 400\text{V}$ $I_C = 25\text{A}, V_{GE} = 15\text{V}$ $R_{G(on)} = 10\Omega, R_{G(off)} = 20\Omega$ Energy loss include "tail" and FWD reverse recovery.	-	26	-	ns	
Rise Time	t_r		-	14	-		
Turn-Off Delay Time	$t_{d(off)}$		-	390	-		
Fall Time	t_f		-	16	-		
Turn-On Energy	E_{on}		-	0.30	-		mJ
Turn-Off Energy	E_{off}	-	0.52	-			
Forward Voltage Drop	V_F	$I_F = 50\text{A}$	$T_{vj} = 25^{\circ}\text{C}$	-	2.5	3.2	V
			$T_{vj} = 125^{\circ}\text{C}$	-	1.9	-	V
			$T_{vj} = 175^{\circ}\text{C}$	-	1.7	-	V
Diode Reverse Recovery Time	t_{rr}	$V_{CC} = 400\text{V}, I_F = 25\text{A}$	-	115	-	ns	
Diode Reverse Recovery Charge	Q_{rr}	$-di/dt = 500\text{A}/\mu\text{s}, T_{vj} = 25^{\circ}\text{C}$	-	0.35	-	μC	
Diode Reverse Recovery Time	t_{rr}	$V_{CC} = 400\text{V}, I_F = 25\text{A}$	-	140	-	ns	
Diode Reverse Recovery Charge	Q_{rr}	$-di/dt = 500\text{A}/\mu\text{s}, T_{vj} = 150^{\circ}\text{C}$	-	1.10	-	μC	

● Thermal Resistance

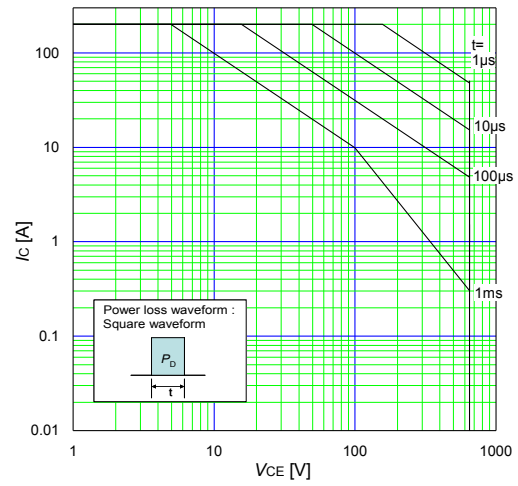
Description	Symbol	min.	typ.	max.	Unit
Thermal Resistance, Junction-Ambient	$R_{th(j-a)}$	-	-	50	°C/W
Thermal Resistance, IGBT Junction to Case	$R_{th(j-c)}_{IGBT}$	-	-	0.448	°C/W
Thermal Resistance, FWD Junction to Case	$R_{th(j-c)}_{FWD}$	-	-	0.862	°C/W

■ Characteristics (Representative)

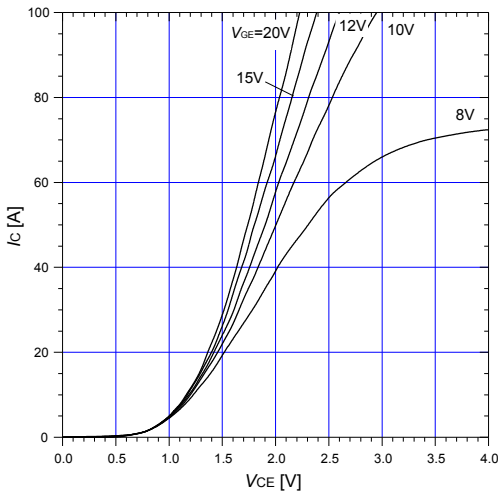
Graph.1
DC Collector Current vs Tc
 $V_{GE} \geq +15V, T_{vj} \leq 175^{\circ}C$



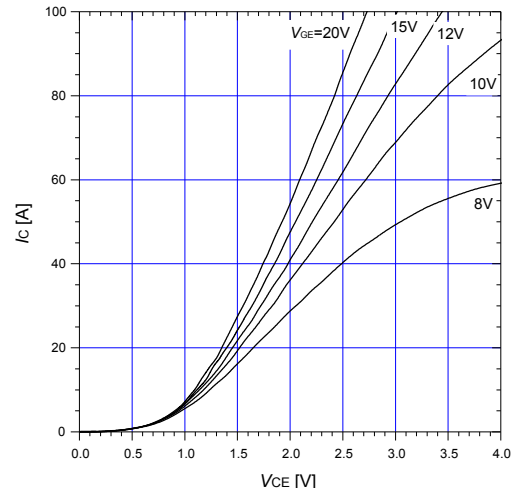
Graph.2
SOA
Duty=0(Single pulse), Tc=25°C



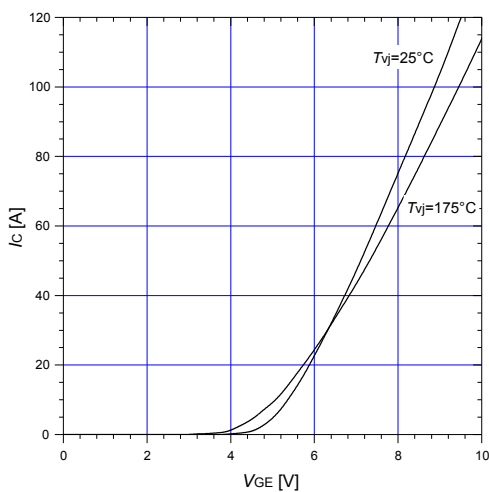
Graph.3
Typical Output Characteristics (VCE-Ic)
Tvj=25°C



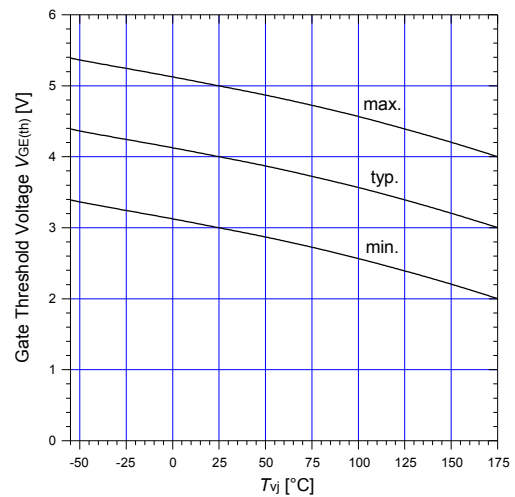
Graph.4
Typical Output Characteristics (VCE-Ic)
Tvj=175°C



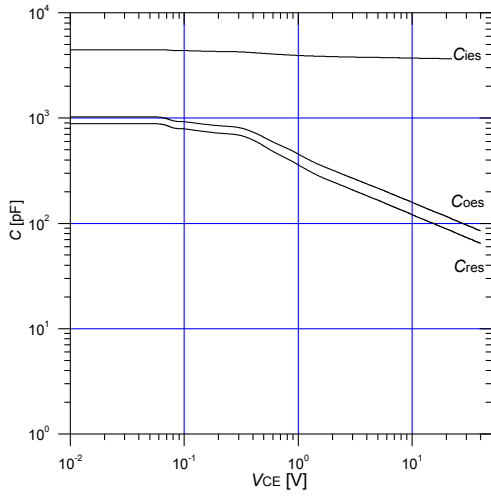
Graph.5
Typical Transfer Characteristics
VCE=10V



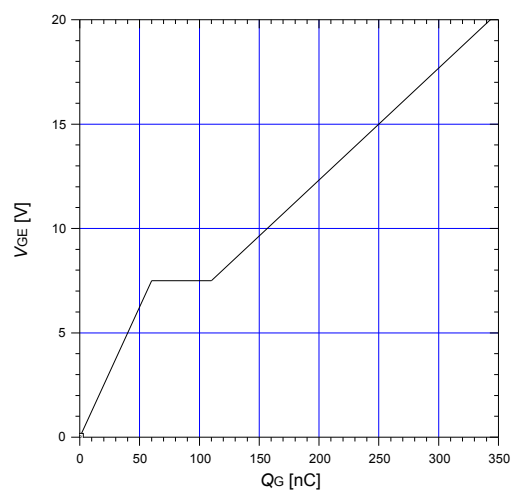
Graph.6
Gate Threshold Voltage vs. Tvj
Ic=50mA, VCE=20V



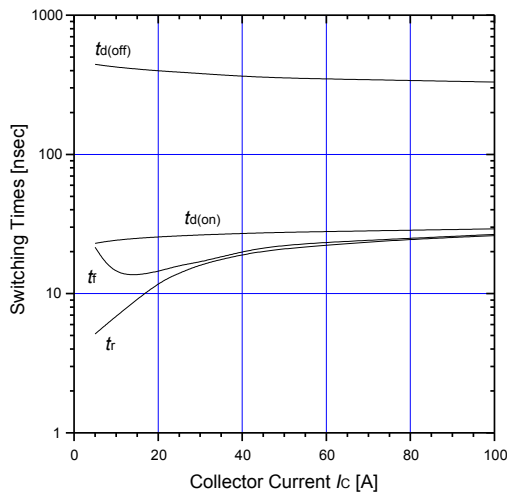
Graph.7
 Typical Capacitance
 $V_{GE}=0V, f=1MHz, T_{vj}=25^{\circ}C$



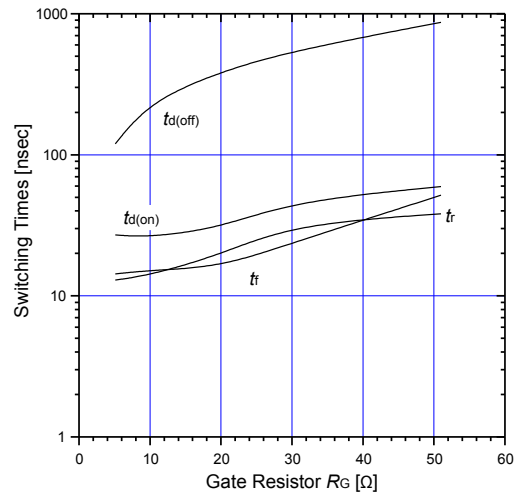
Graph.8
 Typical Gate Charge
 $V_{CC}=520V, I_c=50A, T_{vj}=25^{\circ}C$



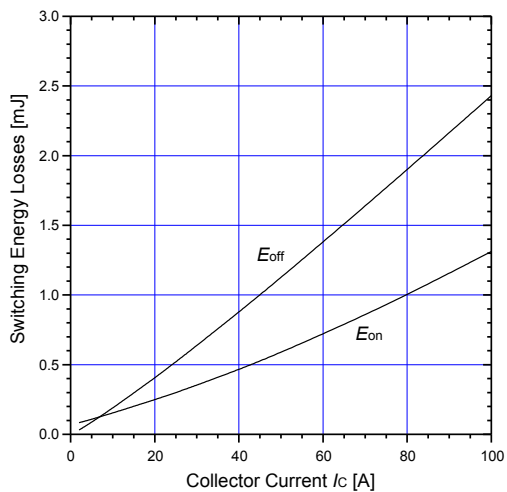
Graph.9
 Typical switching time vs. I_c
 $T_{vj}=150^{\circ}C, V_{CC}=400V$
 $V_{GE}=15V, R_G=+10/-20\Omega$



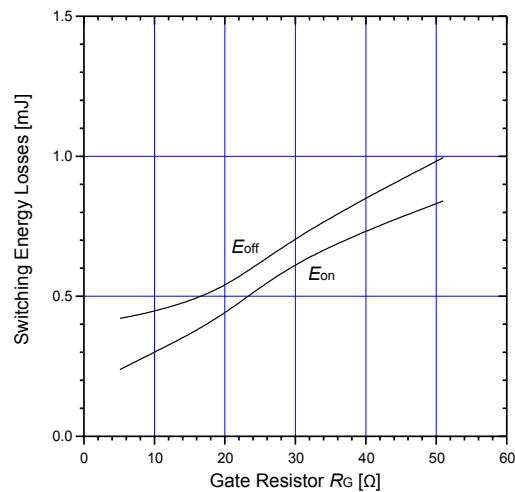
Graph.10
 Typical switching time vs. R_G
 $T_{vj}=150^{\circ}C, V_{CC}=400V, I_c=25A$
 $V_{GE}=15V$



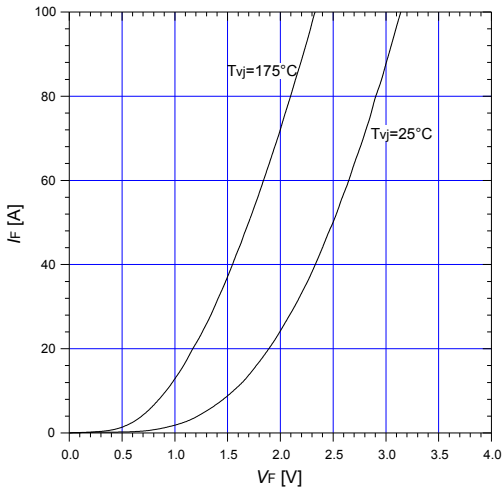
Graph.11
 Typical switching losses vs. I_c
 $T_{vj}=150^{\circ}C, V_{CC}=400V$
 $V_{GE}=15V, R_G=+10/-20\Omega$



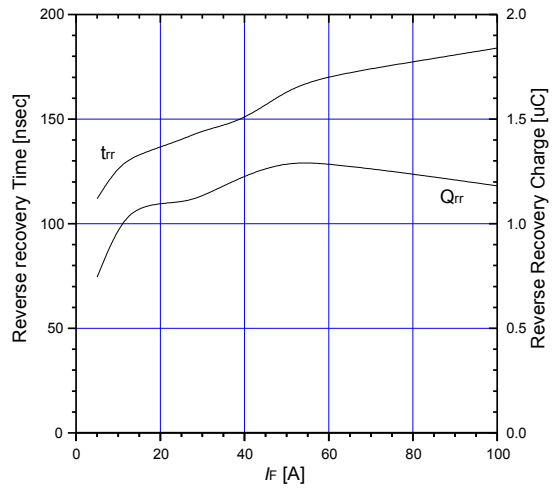
Graph.12
 Typical switching losses vs. R_G
 $T_{vj}=150^{\circ}C, V_{CC}=400V, I_c=25A$
 $V_{GE}=15V$



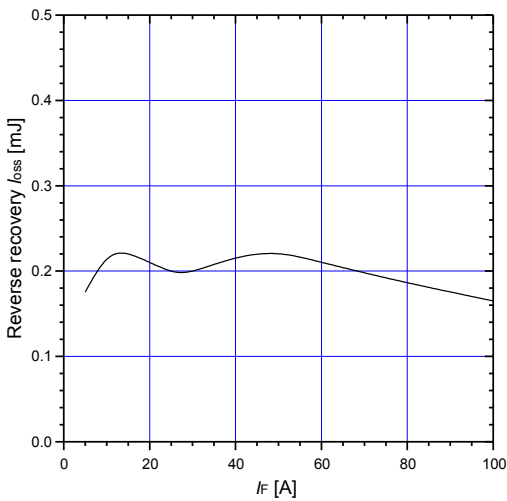
Graph.13
FWD Forward voltage drop (V_F - I_F)



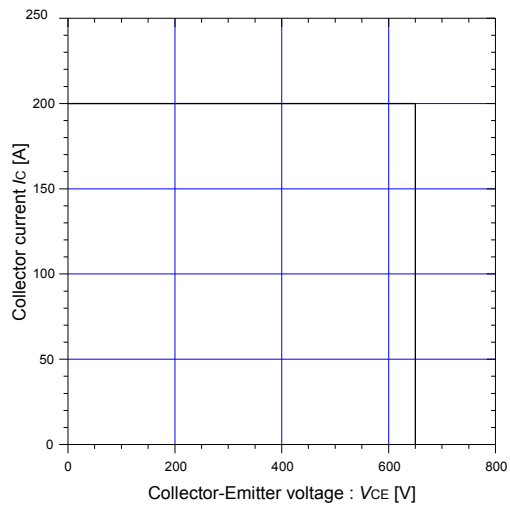
Graph.14
Typical reverse recovery characteristics vs. I_F
 $T_{vj}=150^\circ\text{C}$, $V_{CC}=400\text{V}$, $L=500\mu\text{H}$
 $V_{GE}=15\text{V}$, $R_G=10\Omega$



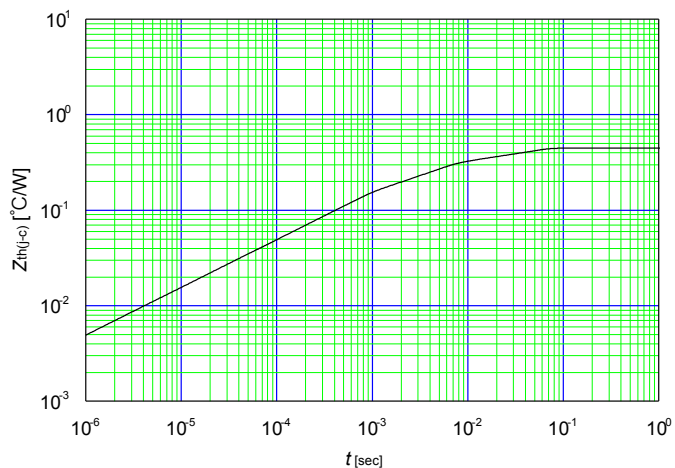
Graph.15
Typical reverse recovery loss vs. I_F
 $T_{vj}=150^\circ\text{C}$, $V_{CC}=400\text{V}$, $L=500\mu\text{H}$
 $V_{GE}=15\text{V}$, $R_G=10\Omega$



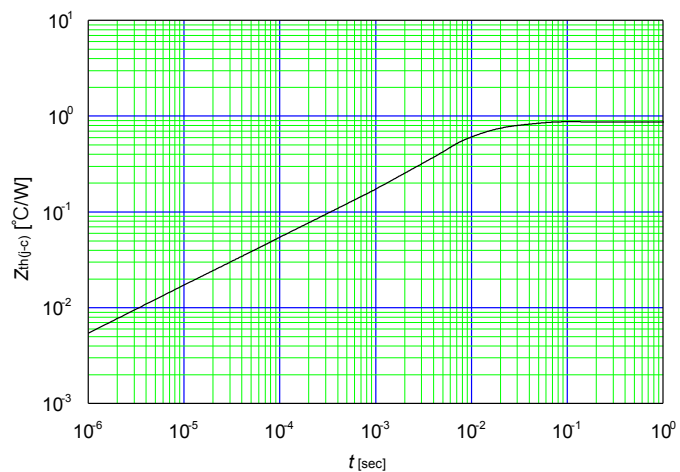
Graph.16
Reverse biased Safe Operating Area
 $T_{vj}\leq 175^\circ\text{C}$, $V_{GE}=+15\text{V}/0\text{V}$, $R_G=10\Omega$



Graph.17
Transient thermal resistance of IGBT

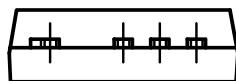
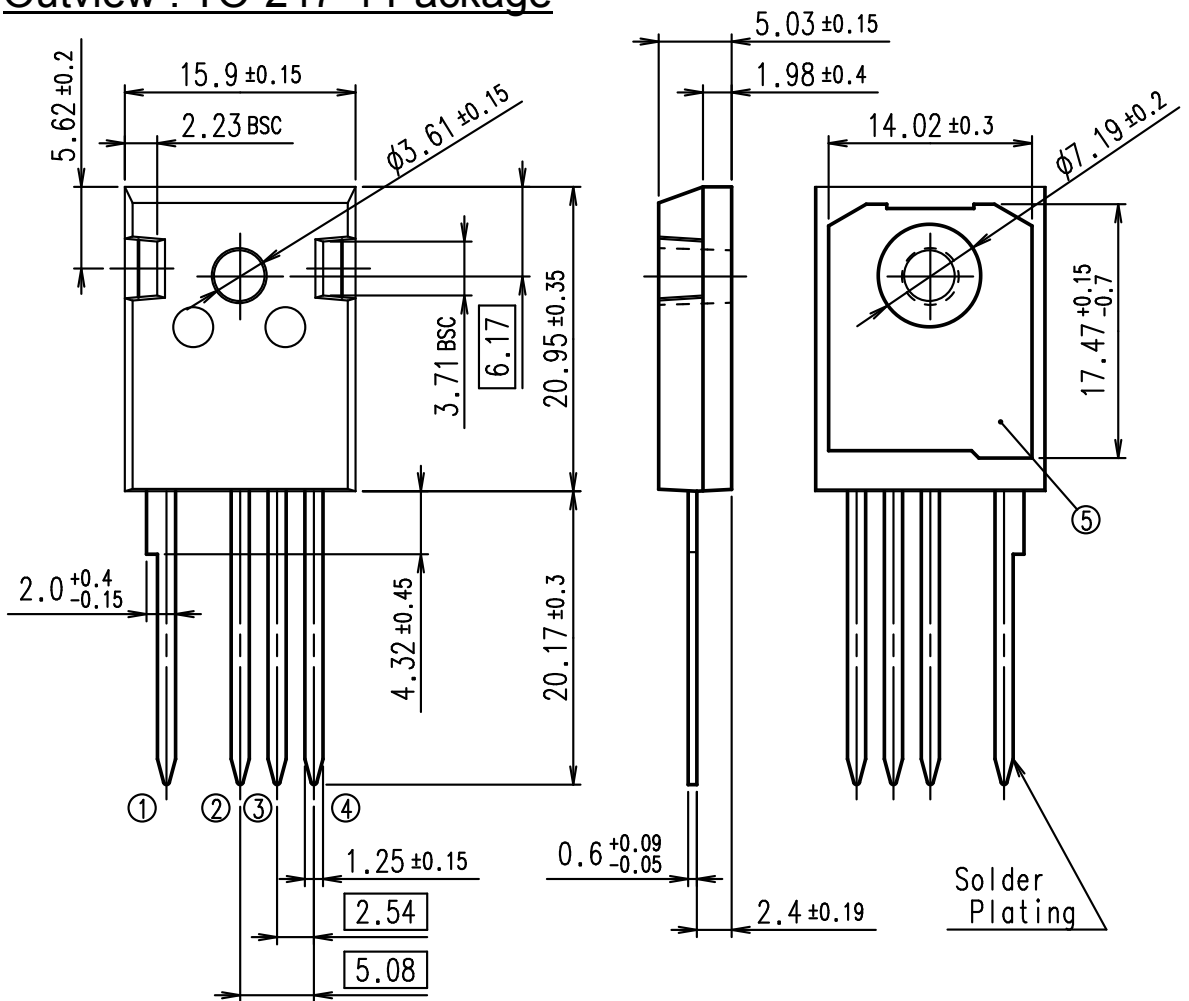


Graph.18
Transient thermal resistance of FWD



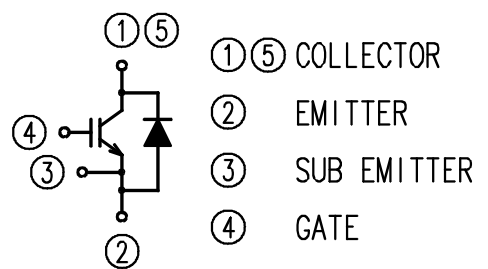
■ Outline Drawings, mm

Outview : TO-247-4 Package



DIMENSIONS ARE IN MILLIMETERS.

CONNECTION



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 - Audiovisual equipment
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